



VIS30940

30V N-Channel SGT MOSFET

General Description

- SGT MOSFET Technology
- Low $R_{DS(ON)}$ at 4.5V V_{GS}
- Low Gate Charge
- High Current Capability
- RoHS and Halogen-Free Compliant

Applications

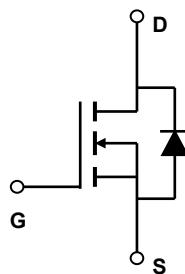
- General DC/DC Converters
- VRM Vcore for Notebook and Server
- Load Switch and Battery Power Management
- Motor Drive Bridge Switch

Product Summary

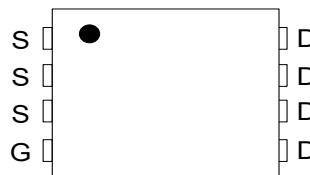
V_{DS}	30V
I_D (at $V_{GS}=10V$)	32A
$R_{DS(ON)}$ (at $V_{GS}=10V$, typ)	4.6mΩ
$R_{DS(ON)}$ (at $V_{GS}=4.5V$, typ)	5.8mΩ

100% UIS Tested

100% R_g Tested

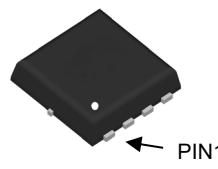


Top View



DFN3.3x3.3

Bottom View



PIN1

Orderable Part Number	Package Type	Form	Minimum Order Quantity
VIS30940	DFN3.3x3.3	Tape & Reel	5000

Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current (5)	I_D	32	A
		32	A
Pulsed Drain Current (3)	I_{DM}	150	A
Continuous Drain Current	I_{DSM}	20	A
		12.5	A
Avalanche Current (3)	I_{AS}	33	A
Avalanche Energy L=0.1mH (3)	E_{AS}	54	mJ
Power Dissipation (2)	P_D	26	W
		10.4	W
Power Dissipation (1)	P_{DSM}	3.1	W
		1.25	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient (1)	$R_{\theta JA}$	30	40	°C/W
Maximum Junction-to-Ambient (1,4)		60	75	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	4	4.8	°C/W



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Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$		1		μA
		$T_J=55^\circ\text{C}$		5		
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.4	1.7	2.3	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$		4.6	5.5	$\text{m}\Omega$
		$T_J=125^\circ$		6.5		
		$V_{GS}=4.5\text{V}, I_D=20\text{A}$		5.8	7.5	
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=20\text{A}$		83		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.72		V
I_S	Maximum Body-Diode Continuous Current				34	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		1575		pF
C_{oss}	Output Capacitance			450		pF
C_{rss}	Reverse Transfer Capacitance			35		pF
R_g	Gate resistance	$f=1\text{MHz}$		2.5		Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=20\text{A}$		23.2		nC
$Q_g(4.5\text{V})$	Total Gate Charge			10.9		nC
Q_{gs}	Gate Source Charge			6.9		nC
Q_{gd}	Gate Drain Charge			1.5		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=0.75\Omega, R_{\text{GEN}}=3\Omega$		8		ns
t_r	Turn-On Rise Time			5		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			12		ns
t_f	Turn-Off Fall Time			5		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=20\text{A}, di/dt=200\text{A}/\mu\text{s}$		22		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=20\text{A}, di/dt=200\text{A}/\mu\text{s}$		20		nC

- 1) R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The Power dissipation P_{DSM} is based on $R_{\text{BJA}} \leq 10\text{s}$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design.
- 2) The power dissipation P_D is based on $T_{J(\text{MAX})}=150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- 3) Single pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$.
- 4) R_{BJA} is the sum of the thermal impedance from junction to case R_{BJC} and case to ambient.
- 5) The maximum current rating is package limited.



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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

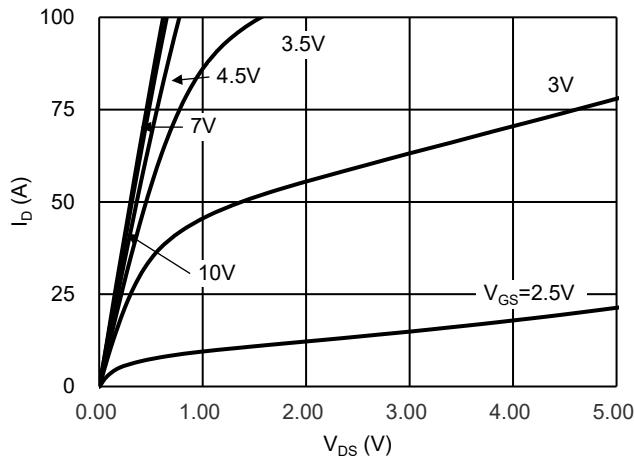


Fig 1. Typical Output Characteristics

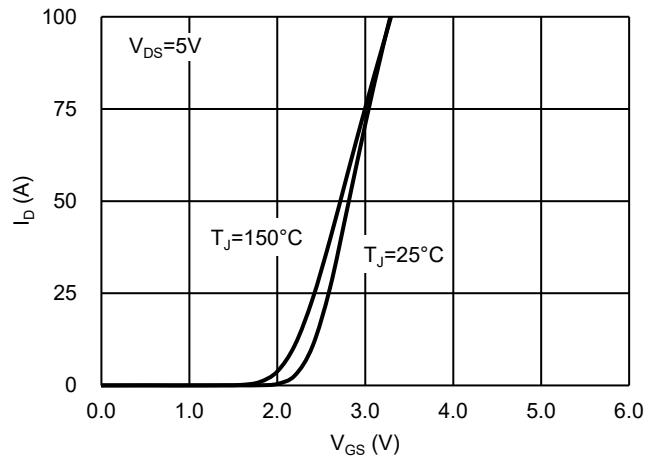


Fig 2. Typical Transfer Characteristics

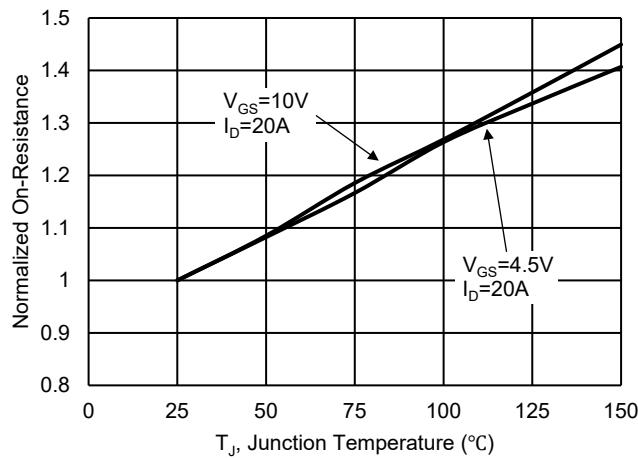


Fig 3. Normalized On-Resistance vs. Temperature

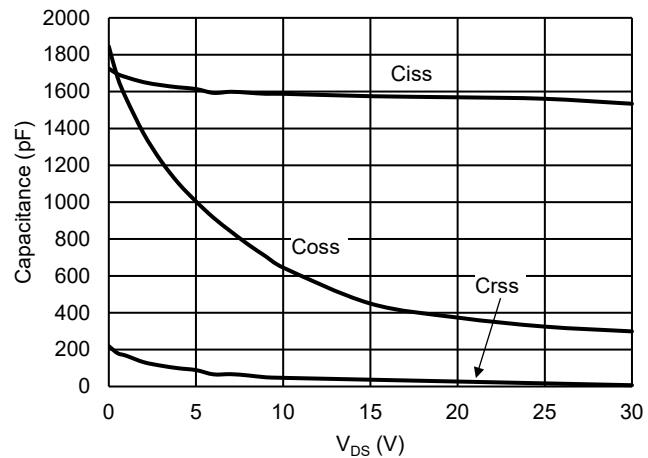


Fig 4. Typical Capacitance vs. V_{DS}

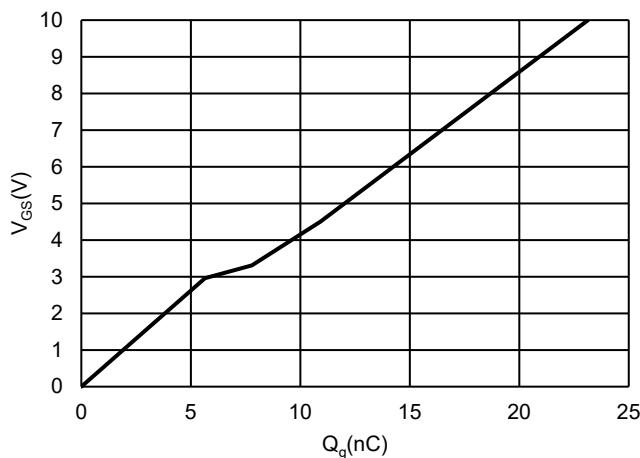


Fig 5. Typical Gate Charge vs. V_{GS}

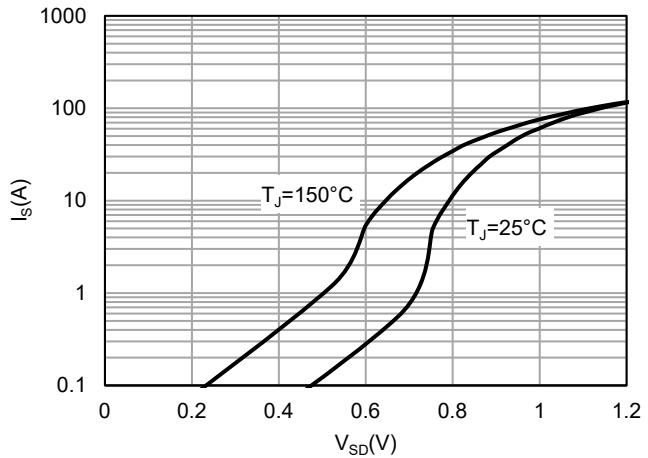


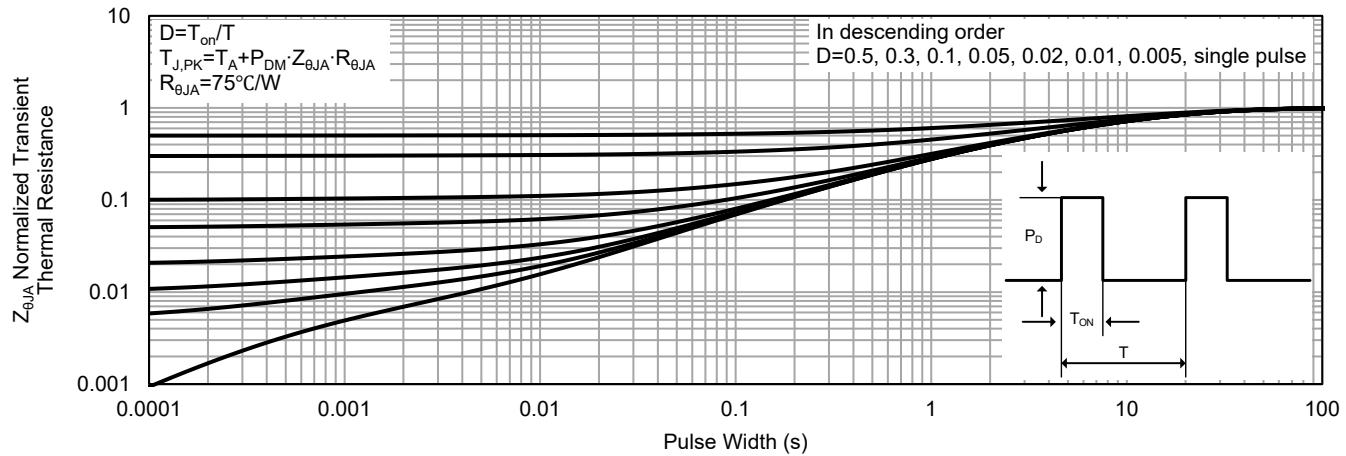
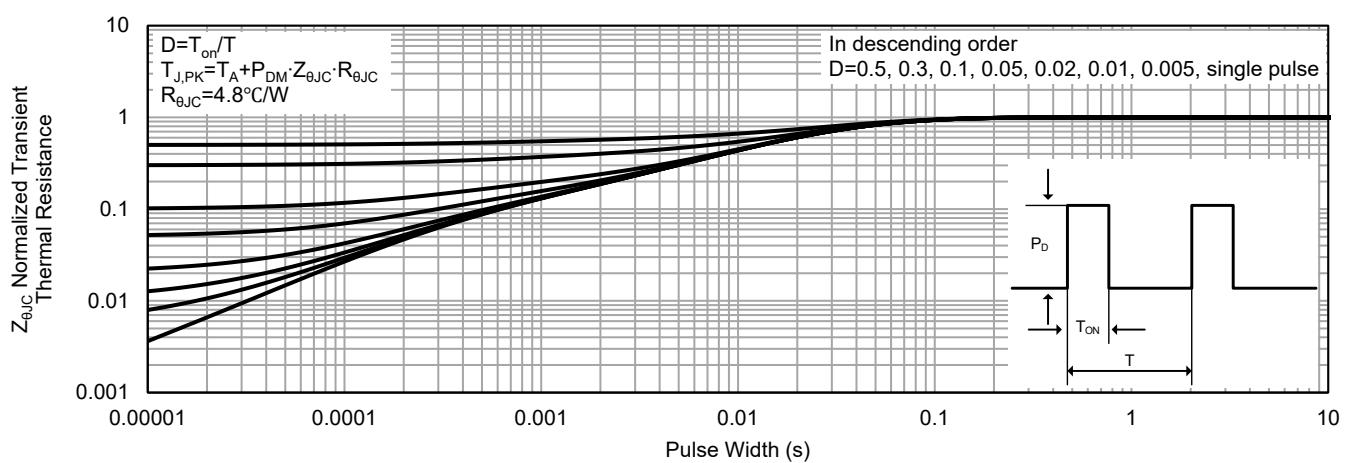
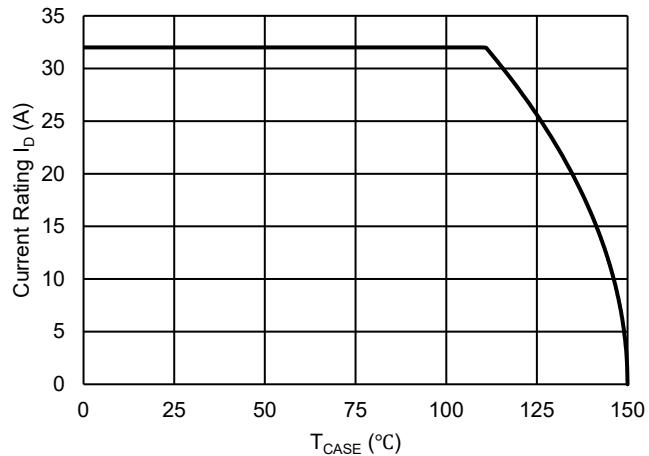
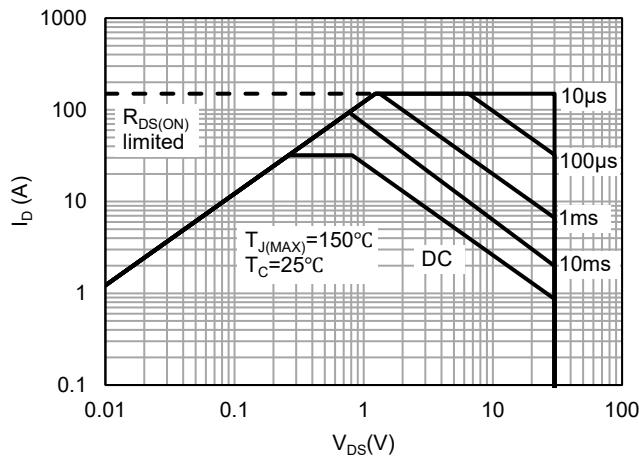
Fig 6. Typical Source-Drain Diode Forward Voltage



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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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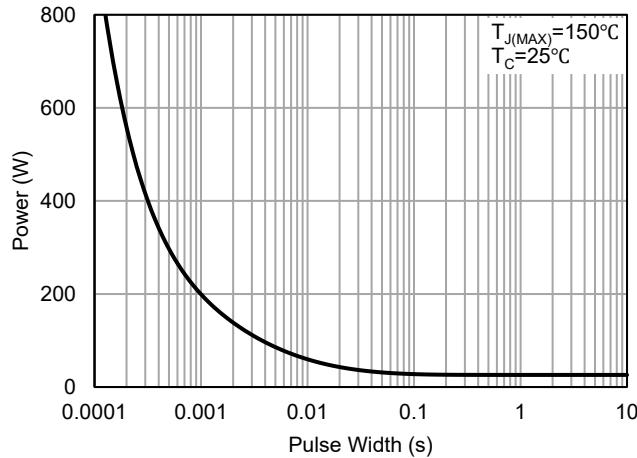


Fig 11. Single Pulse Power Rating Junction-to-Case

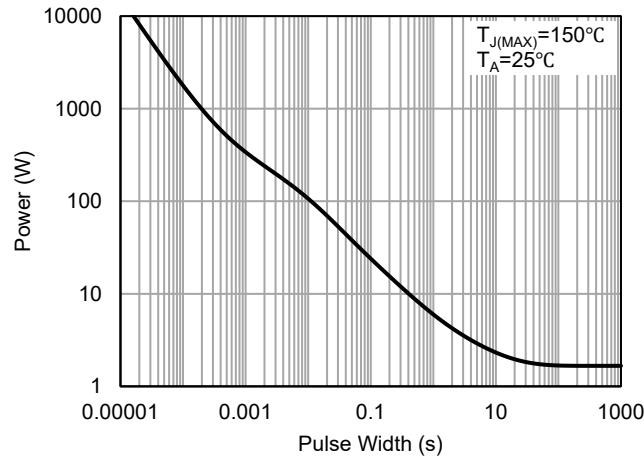


Fig 12. Single Pulse Power Rating Junction-to-Ambient

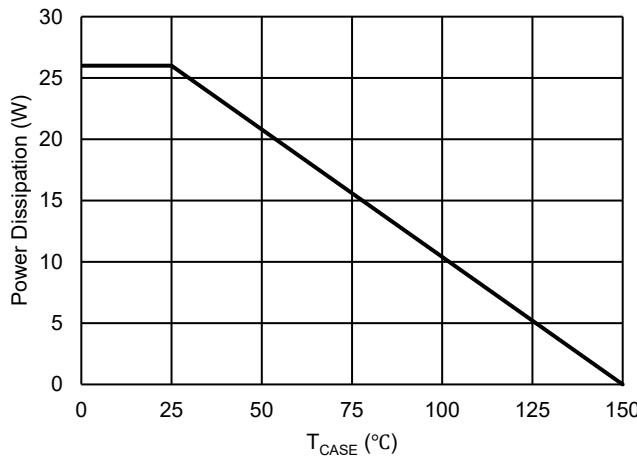


Fig 13. Maximum Power Rating vs. Temperature

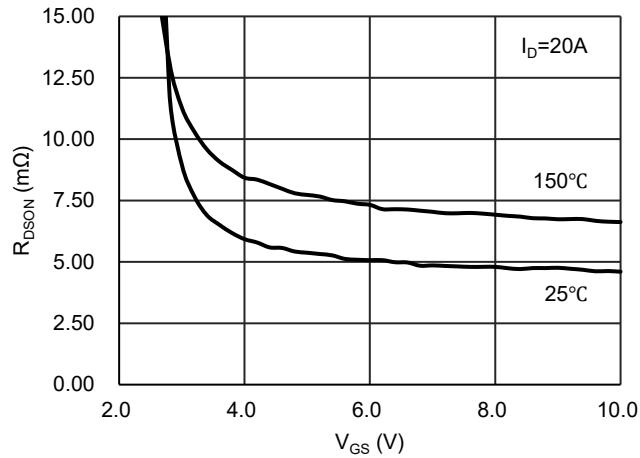


Fig 14. On-Resistance vs. V_{GS}

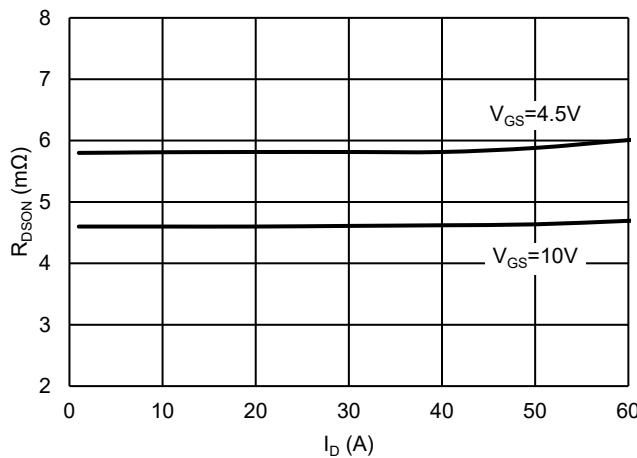


Fig 15. On-Resistance vs. Drain Current



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TEST CIRCUIT

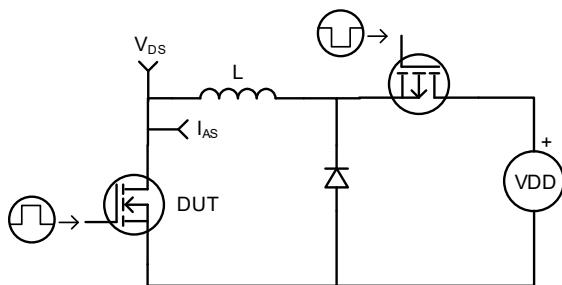


Fig16. Unclamped Inductive Test Circuit

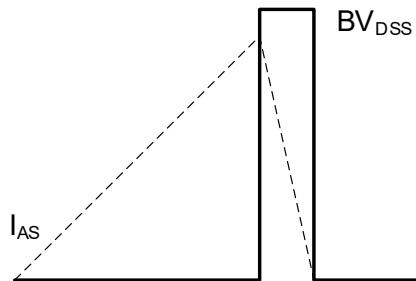


Fig17. Unclamped Inductive Waveform

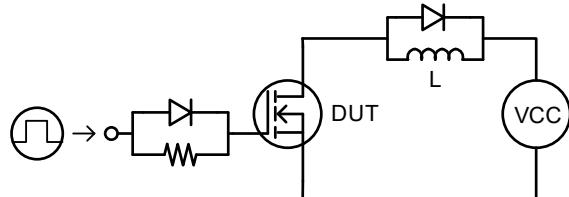


Fig18. Q_g Test Circuit

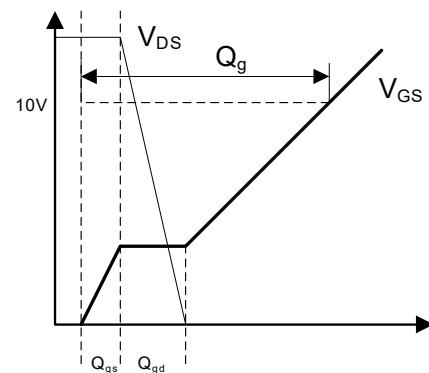


Fig19. Q_g Waveform

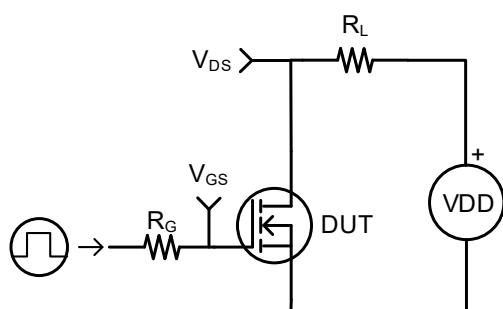


Fig18. Resistive Switching Test Circuit

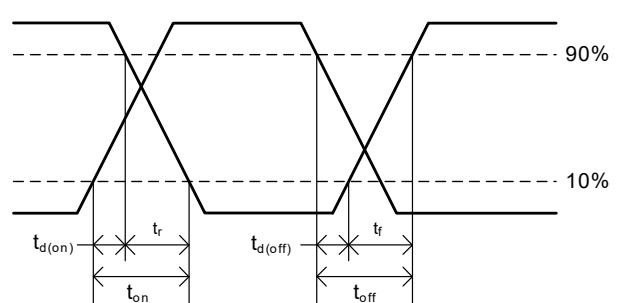


Fig19. Switching Time Waveform



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TEST CIRCUIT

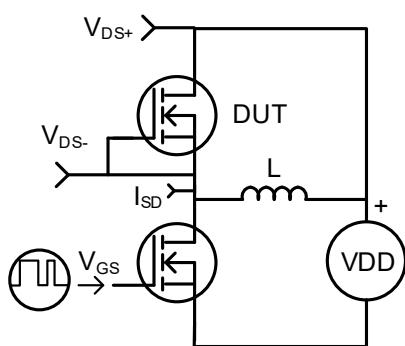


Fig20. Diode Recovery Test Circuit

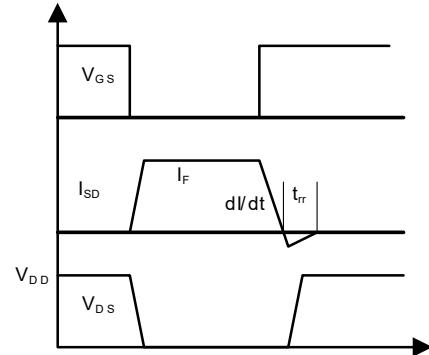
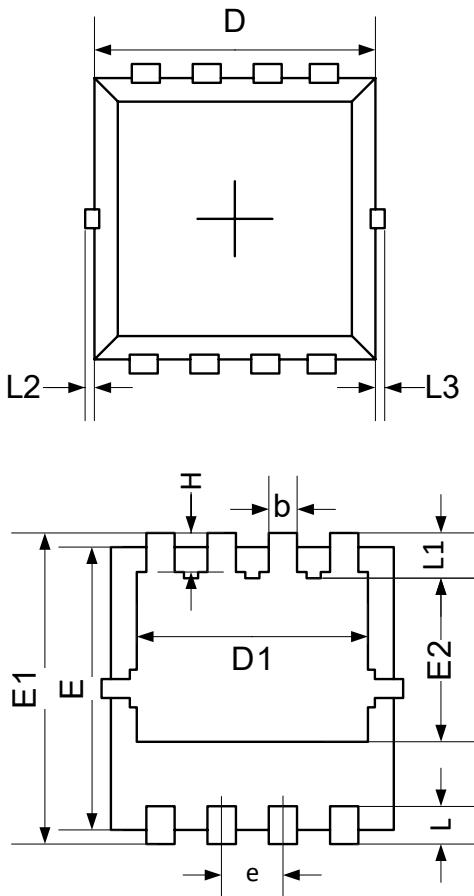


Fig21. Diode Recovery Test Waveform

DFN3.3x3.3 OUTLINE



DIM SYMBOL	MILLIMITERS	
	MIN [mm]	MAX [mm]
A	0.650	0.850
A1	0.152 REF	
A2	0~0.05	
D	2.900	3.100
D1	2.300	2.600
E	2.900	3.100
E1	3.150	3.450
E2	1.535	1.935
b	0.200	0.400
e	0.550	0.750
L	0.300	0.500
L1	0.180	0.480
L2	0~0.100	
L3	0~0.100	
H	0.315	0.515
θ	9°	13°

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